



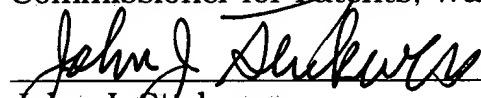
#23/E
3/17/3
Sunder

THE UNITED STATES PATENT AND TRADEMARK OFFICE

Applicant(s): Tabrizi, B. Atty. Dkt. 1920/107
Serial No.: 09/677,291 Art Unit: 2815
Date Filed: October 2, 2000 Examiner: C. Chu
Invention: SEMICONDUCTOR PACKAGING

CERTIFICATE OF MAILING

I hereby certify that this correspondence is being deposited with the United States Postal Service as first class mail in an envelope addressed to Commissioner for Patents, Washington, D.C. 20231 on February 27, 2003.



John J. Stickevers

Commissioner for Patents
Washington, DC 20231

RESPONSE E

Dear Sir:

In response to the Office Action mailed on November 26, 2002 entry of the following amendments is requested.

In the Drawings:

Correction has been made to Fig. 1 to overcome the objection so that the figures now comply with 37 CFR 1.83(a).